

## TRANSMITTAL OF APPEAL BRIEF (Large Entity)

Docket No.  
87552.99R134

In Re Application Of: Linn et al.

MAY 24 2001

PATENT &amp; TRADEMARK OFFICE 4705

Serial No.  
09/316,580Filing Date  
May 21, 1999Examiner  
S. LokeGroup Art Unit  
2811

Invention: BONDED WAFER WITH METAL SILICIDATION

TO THE ASSISTANT COMMISSIONER FOR PATENTS:

Transmitted herewith in triplicate is the Appeal Brief in this application, with respect to the Notice of Appeal filed on

The fee for filing this Appeal Brief is: \$300.00

- ☐ A check in the amount of the fee is enclosed.
- ☐ The Commissioner has already been authorized to charge fees in this application to a Deposit Account. A duplicate copy of this sheet is enclosed.
- ☒ The Commissioner is hereby authorized to charge any fees which may be required, or credit any overpayment to Deposit Account No. 10-0223  
A duplicate copy of this sheet is enclosed.



Signature

Dated:

May 22, 2001

Lee J. Fleckenstein  
Registration No. 36,136  
JAECKLE FLEISCHMANN & MUGEL, LLP  
39 State Street  
Rochester, NY 14614  
Telephone: (716) 262-3640  
Fax: (716) 262-4133

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Applicant(s): Jack H. Linn, Robert K. Lowry et al.

Docket No.

87552.99R134/SE-906D

Serial No.

09/316,580

Filing Date

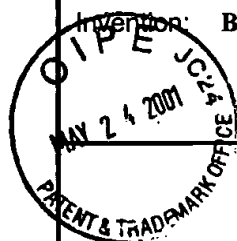
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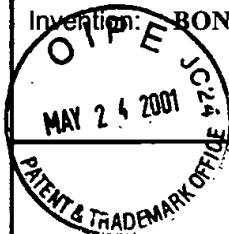
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S. Loke

Group Art Unit

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Invention: **BONDED WAFER WITH METAL SILICIDATION**



I hereby certify that this Amendment Accompanying Revised Appeal Brief (in triplicate/total 3 pages)

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